

SPECIFICATION

DYNAMIC MICROPHONE CARTRIDGE DT-05

1. PRODUCT OUTLINE

- 1-1. PART NO. : DT-05
- 1-2. DIMENSIONS: As shown drawing no. (CONFIG. 1)
- 1-3. WEIGHT : $35 \pm 3\text{g}$
- 1-4. DIMENSION : $\phi 35 \times 17.8\text{mm}$
- 1-5. STANDARD TEST

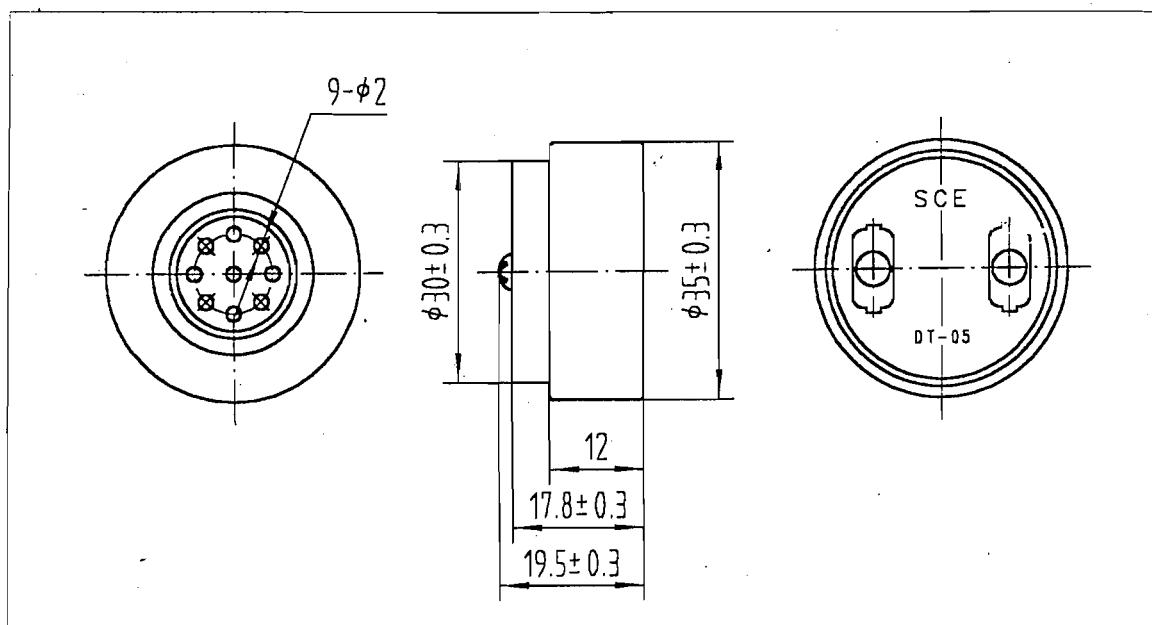
CONDITIONS: The test conditions unless other with specified shall be
5~35°C (Normal Temperature), 45~85% (Normal Humidity),
and 880~1060Pa (Normal Atmospheric Pressure)

2. ELECTRICAL SPECIFICATIONS

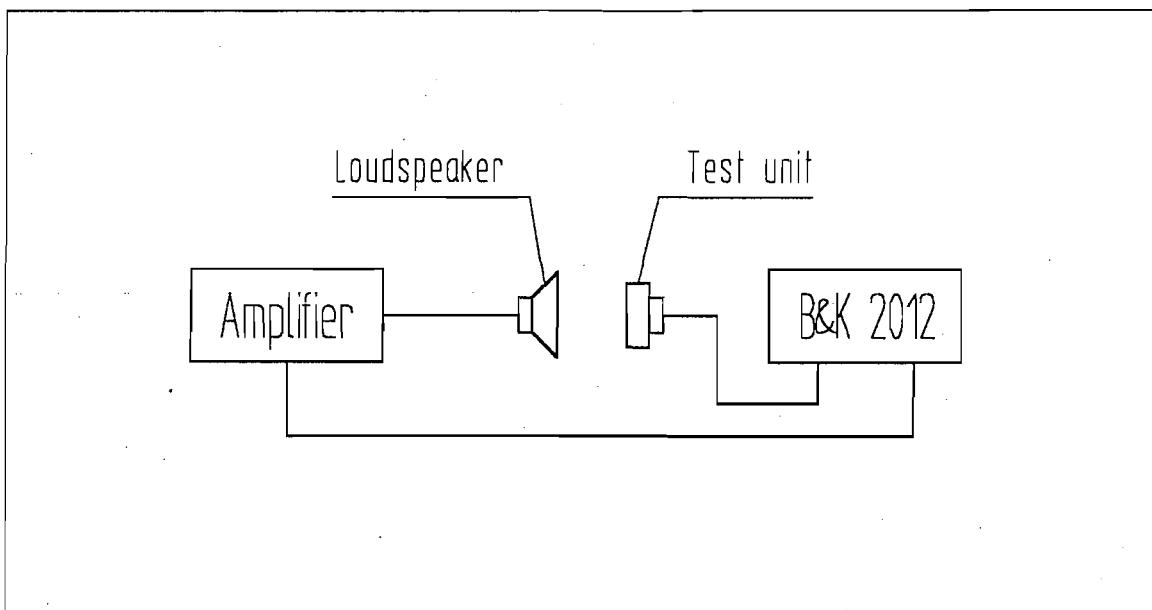
- 2-1. SENSITIVITY: $-56 \pm 3\text{dB}$ S. P. L at 1 KHz ($0\text{dB}=1\text{Pa/V}$)
- 2-2. IMPEDANCE : $150 \pm 30\text{ohm}$ at 1kHz By substitution method of resistance
- 2-3. TEST CIRCUIT (CONFIG. 2)
- 2-4. FREQUENCY RESPONSE (CONFIG. 3)
The 1kHz sensitivity requirements must be met and the frequency response shall lie between the movable envelope limits shown in CONFIG. 3

ISSUE BY	DATE	CHKD	DATE	APPVD	DATE	REMARK
Y. N. W. b	2000.2.2	price	2000.2.2.	100% (良)	2000.2.2	

3. CONFIG. 1

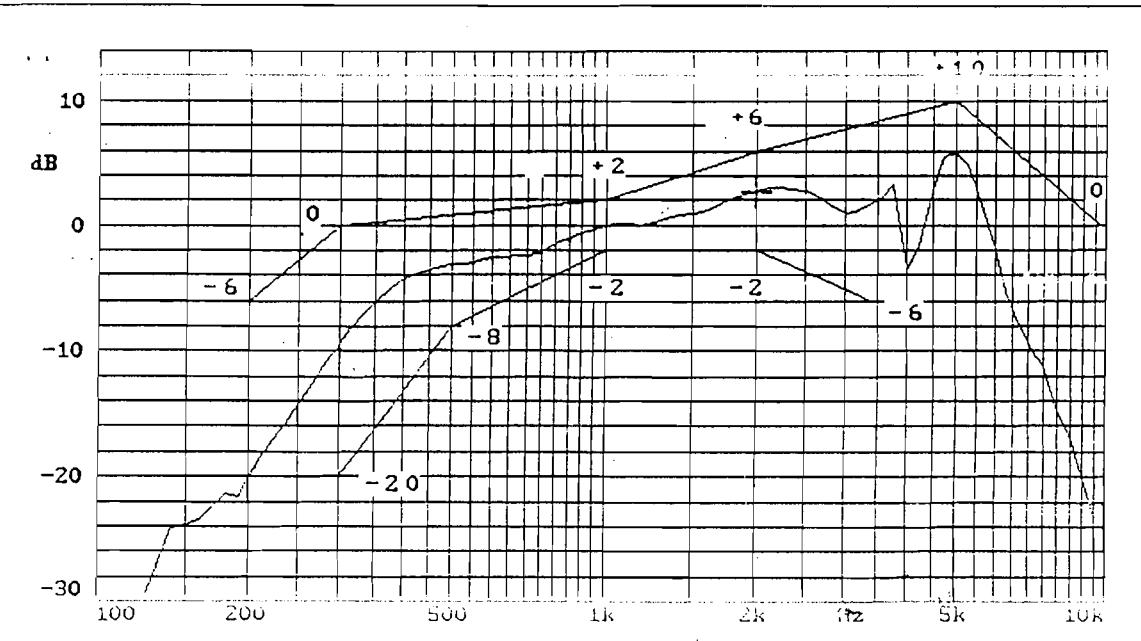


4. CONFIG. 2



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孫志輝	2000.2.2	孫志輝	2000.2.2	陳仁謙	2000.2.2	

5. CONFIG. 3



6. ENVIRONMENTAL TESTS

6.1 GENERAL

AFTER ANY FOLLOWING TESTS, THE RESPONSE AT 1kHz SHALL NOT DEVIATE MORE THAN ± 3 dB FROM THE INITIAL VALUE

6.2 HIGH TEMPERATURE AGING TEST

a. Temperature: $+60 \pm 2^\circ\text{C}$ b. Duration: 96hours c. Duration of recovery : 3 hours

6.3 LOW TEMPERATURE AGING TEST

a. Temperature: $-20 \pm 3^\circ\text{C}$ b. Duration: 96hours c. Duration of recovery: 3 hours

6.4 HUMIDITY TEST

a. Relative humidity: $90\% \pm 2\%$ at $40 \pm 2^\circ\text{C}$ b. Duration: 96 hours
c. Duration of recovery : 3 hours

6.5 DROP TEST

a. UNIT ONLY

The cartridge shall withstand 10 random drops from a height of 75CM to concrete floor, and there shall be no mechanical damage

b. FIXED IN HANDSET

The cartridge, when properly mounted in a handset, shall withstand 20 random drops from a height of 1 meter to a concrete floor, and there shall be no mechanical damage.

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Y. S. Wu	2000.2.3	Y. S. Wu	2000.2.2	Y. S. Wu	2000.2.2	